



N 沟道增强型场效应晶体管 N-CHANNEL MOSFET FHF10N80D/FHA10N80D

主要参数 MAIN CHARACTERISTICS

ID	10 A
VDSS	800 V
Rdson-typ (@Vgs=10V)	0.65 Ω
Qg-typ	53.1 nC

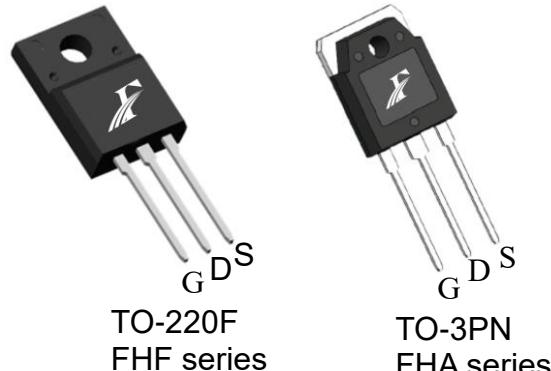
用途 APPLICATIONS

高频开关电源	High efficiency switch mode power supplies
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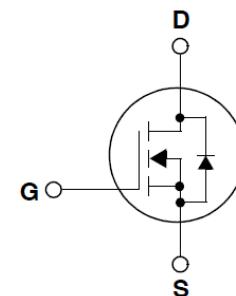
产品特性 FEATURES

低栅极电荷	Low gate charge
低 Crss (典型值 4.2 pF)	Low Crss (typical 4.2 pF)
开关速度快	Fast switching
100% 经过雪崩测试	100% avalanche tested
100% 经过热阻测试	100% DVDS tested
100% 经过 Rg 测试	100% Rg tested
高抗 dv/dt 能力	Improved dv/dt capability
平面工艺	Plane process
RoHS 产品	RoHS product

封装形式 Package



等效电路 Equivalent Circuit



绝对最大额定值 ABSOLUTE RATINGS (Tc=25°C)

项目 Parameter	符号 Symbol	数值 Value		单位 Unit
		FHF10N80D	FHA10N80D	
最高漏极—源极直流电压 Drain-Source Voltage	VDS	800		V
连续漏极电流* Drain Current -continuous *	I _D (T _c =25°C)	10		A
	I _D (T _c =100°C)	6.5		A
最大脉冲漏极电流 (注 1) Drain Current – pulse (note 1)	I _{DM}	40		A
最高栅源电压 Gate-Source Voltage	V _{GS}	±30		V
单脉冲雪崩能量 (注 2) Single Pulsed Avalanche Energy (note 2)	E _{AS}	211.25		mJ
雪崩电流 (注 1) Avalanche Current (note 1)	I _{AR}	6.5		A
重复雪崩能量 (注 1) Repetitive Avalanche Current (note 1)	E _{AR}	25		mJ
二极管反向恢复最大电压变化速率 (注 3) Peak Diode Recovery dv/dt (note 3)	dv/dt	5.0		V/ns
耗散功率 Power Dissipation	P _D (TC=25°C)	62.5	200	W
	-Derate above 25°C	0.5	1.6	W/°C
最高结温及存储温度 Operating and Storage Temperature Range	T _J , T _{STG}	150, -55 to 150		°C
引线最高焊接温度 Maximum Lead Temperature for Soldering Purposes	T _L	300		°C

*漏极电流由最高结温限制

*Drain current limited by maximum junction temperature

电特性 ELECTRICAL CHARACTERISTICS

项目 Parameter	符号 Symbol	测试条件 Tests conditions	最小 Min	典型 Typ	最大 Max	单位 Units	
关态特性 Off -Characteristics							
漏一源击穿电压 Drain-Source Voltage	BVDSS	ID=250μA, VGS=0V	800	-	-	V	
击穿电压温度特性 Breakdown Voltage Temperature Coefficient	ΔBVDSS/Δ TJ	ID=250μA, referenced to 25°C	-	0.8	-	V/°C	
零栅压下漏极漏电流 Zero Gate Voltage Drain Current	IDSS	VDS=800V, VGS=0V, TC=25°C	-	-	1	μA	
		VDS=640V, TC=125°C	-	-	100	μA	
栅极体漏电流 Gate-body leakage current	IGSS (F/R)	VDS=0V, VGS =±30V	-	-	±100	nA	
通态特性 On-Characteristics							
阈值电压 Gate Threshold Voltage	VGS(th)	VDS = VGS, ID=250μA	2.0	3.0	4.0	V	
静态导通电阻 Static Drain-Source On-Resistance	RDS(ON)	VGS =10V , ID=5A	-	0.65	0.80	Ω	
正向跨导 Forward Transconductance	gfs	VDS = 15V, ID=5A (note 4)	-	11	-	S	
动态特性 Dynamic Characteristics							
栅电阻 Gate Resistance	Rg	f=1.0MHz, VDS OPEN	-	2.1	-	Ω	
输入电容 Input capacitance	Ciss	VDS=25V, VGS =0V, f=1.0MHz	-	2910	-	pF	
输出电容 Output capacitance	Coss		-	245	-		
反向传输电容 Reverse transfer capacitance	Crss		-	4.2	-		
开关特性 Switching Characteristics							
延迟时间 Turn-On delay time	td(on)	VDS=400V, ID=10A, RG=20Ω VGS =10V (note 4, 5)	-	40	-	ns	
上升时间 Turn-On rise time	tr		-	110	-	ns	
延迟时间 Turn-Off delay time	td(off)		-	80	-	ns	
下降时间 Turn-Off Fall time	tf		-	70	-	ns	
栅极电荷总量 Total Gate Charge	Qg	VDS =640V , ID=10A , VGS =10V (note 4, 5)	-	53.1	-	nC	
栅一源电荷 Gate-Source charge	Qgs		-	14.5	-	nC	
栅一漏电荷 Gate-Drain charge	Qgd		-	18.4	-	nC	
漏一源二极管特性及最大额定值 Drain-Source Diode Characteristics and Maximum Ratings							
正向最大连续电流 Maximum Continuous Drain -Source Diode Forward Current	Is		-	-	10	A	
正向最大脉冲电流 Maximum Pulsed Drain-Source Diode Forward Current	ISM		-	-	40	A	
正向压降 Drain-Source Diode Forward Voltage	VSD	VGS=0V, Is=10A	-	-	1.2	V	
反向恢复时间 Reverse recovery time	trr	VGS=0V, Is=10A ,dI/dt=100A/μs (note 4)	-	600	-	ns	
反向恢复电荷 Reverse recovery charge	Qrr		-	5214	-	nC	

热特性 THERMAL CHARACTERISTIC

项目 Parameter	符号 Symbol	FHF10N80D	FHA10N80D	单位 Unit
结到管壳的热阻 Thermal Resistance, Junction to Case	R _{th(j-c)}	2.0	0.62	°C/W
结到环境的热阻 Thermal Resistance, Junction to Ambient	R _{th(j-A)}	62.5	40	°C/W

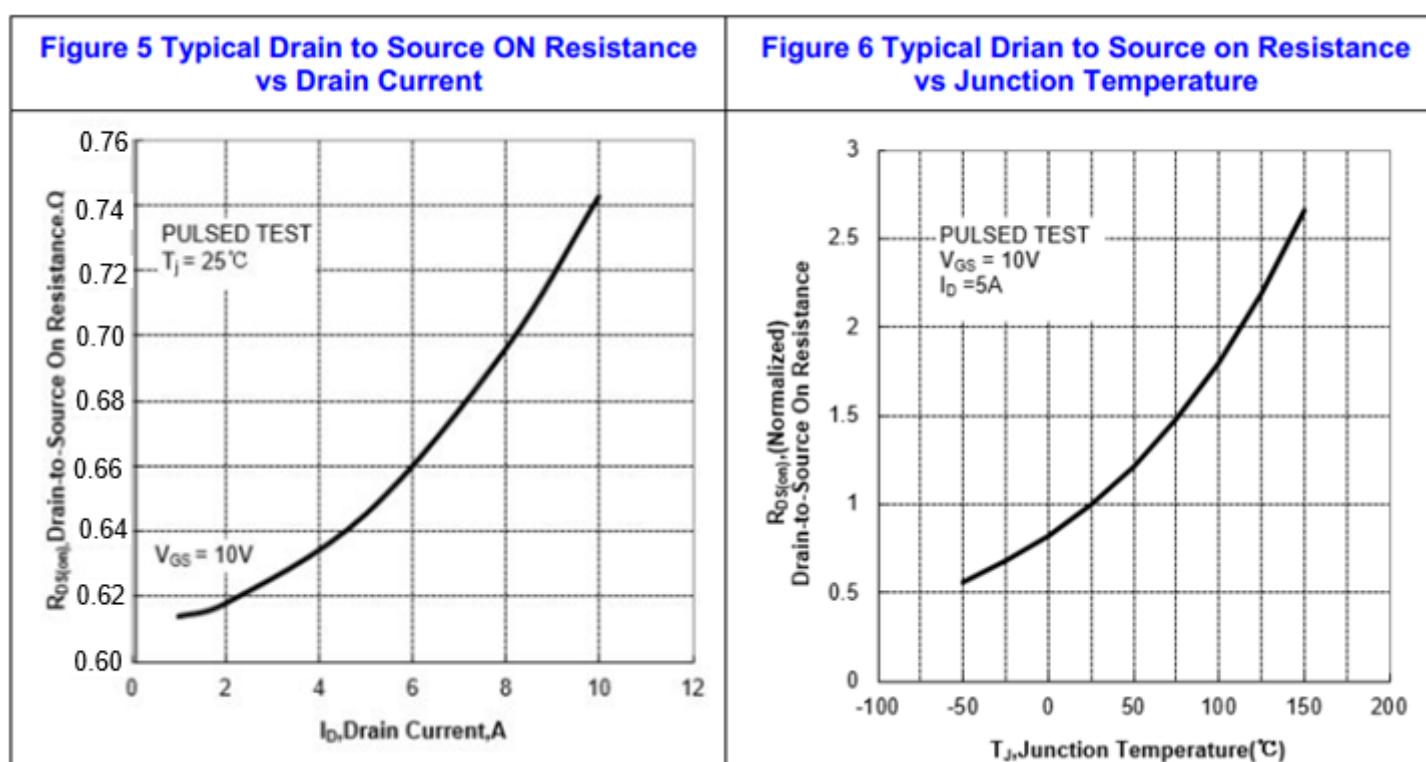
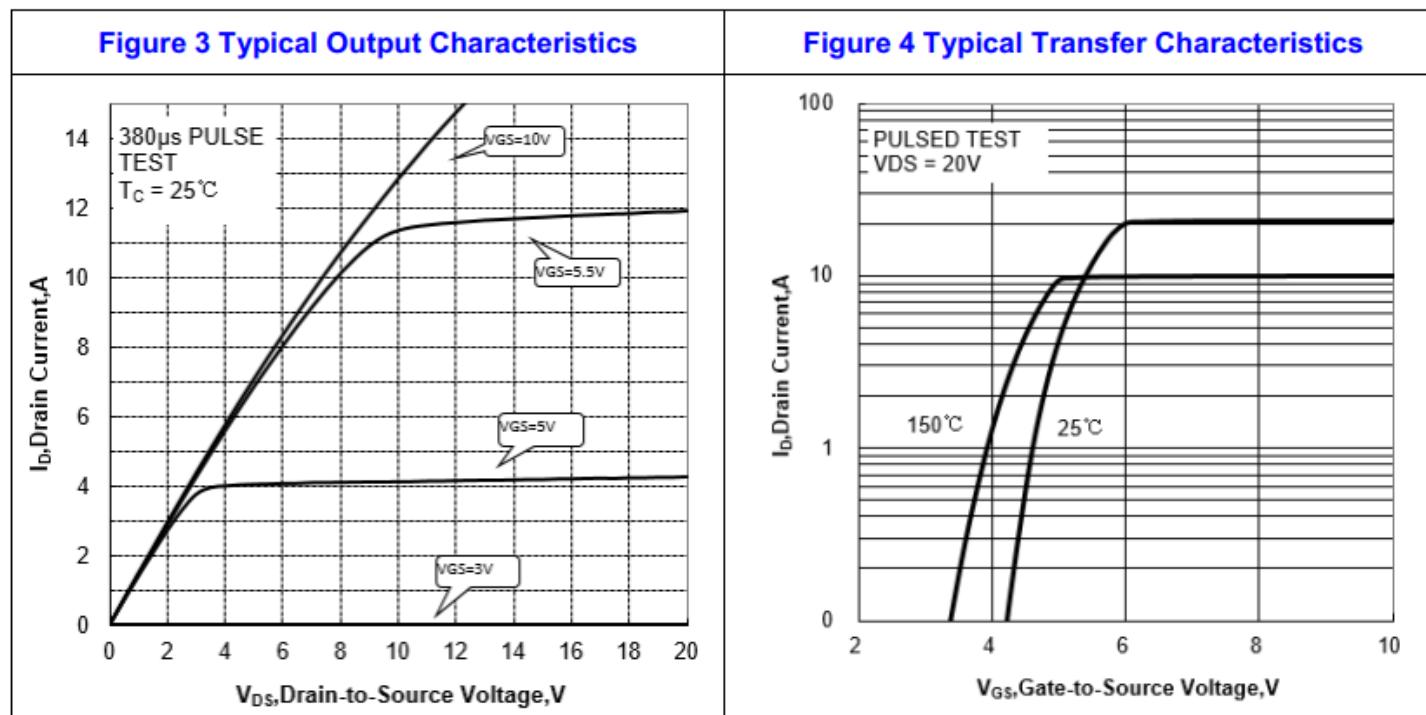
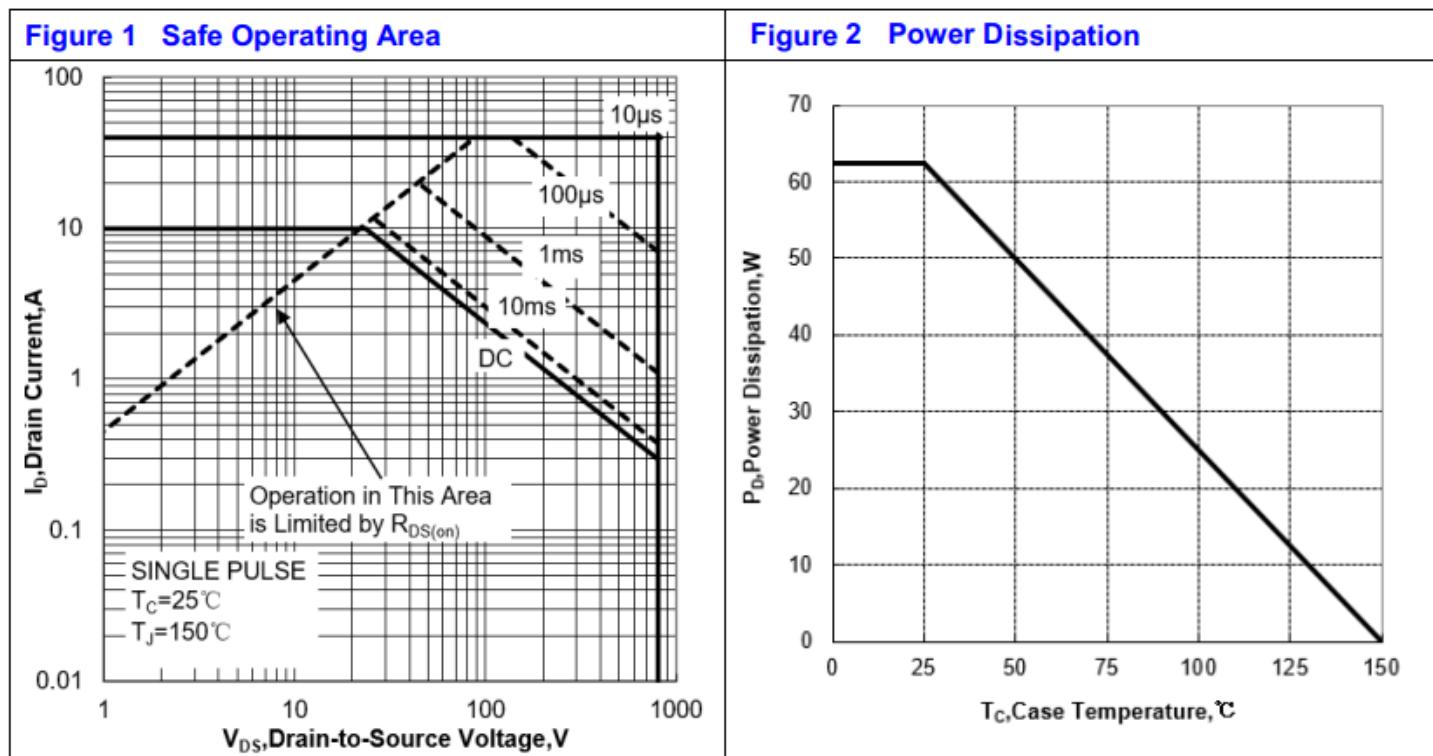
注释:

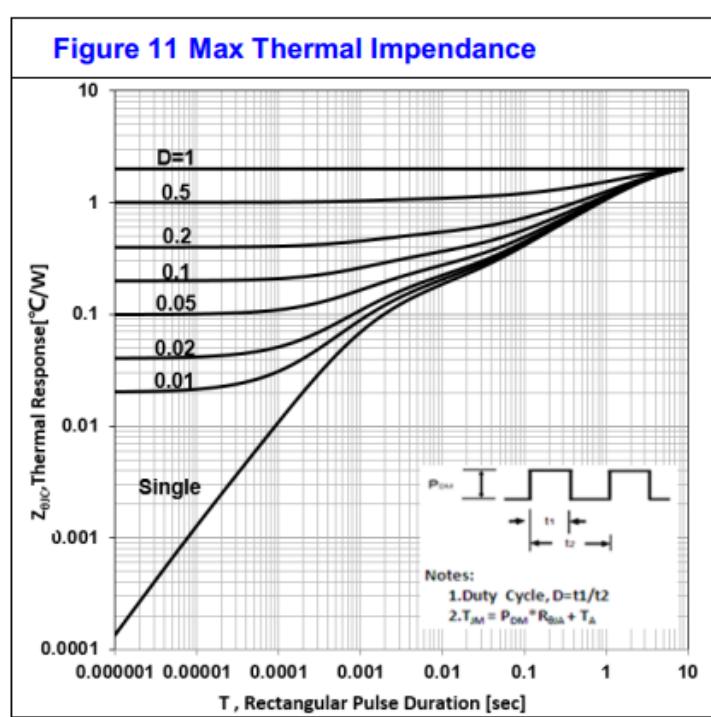
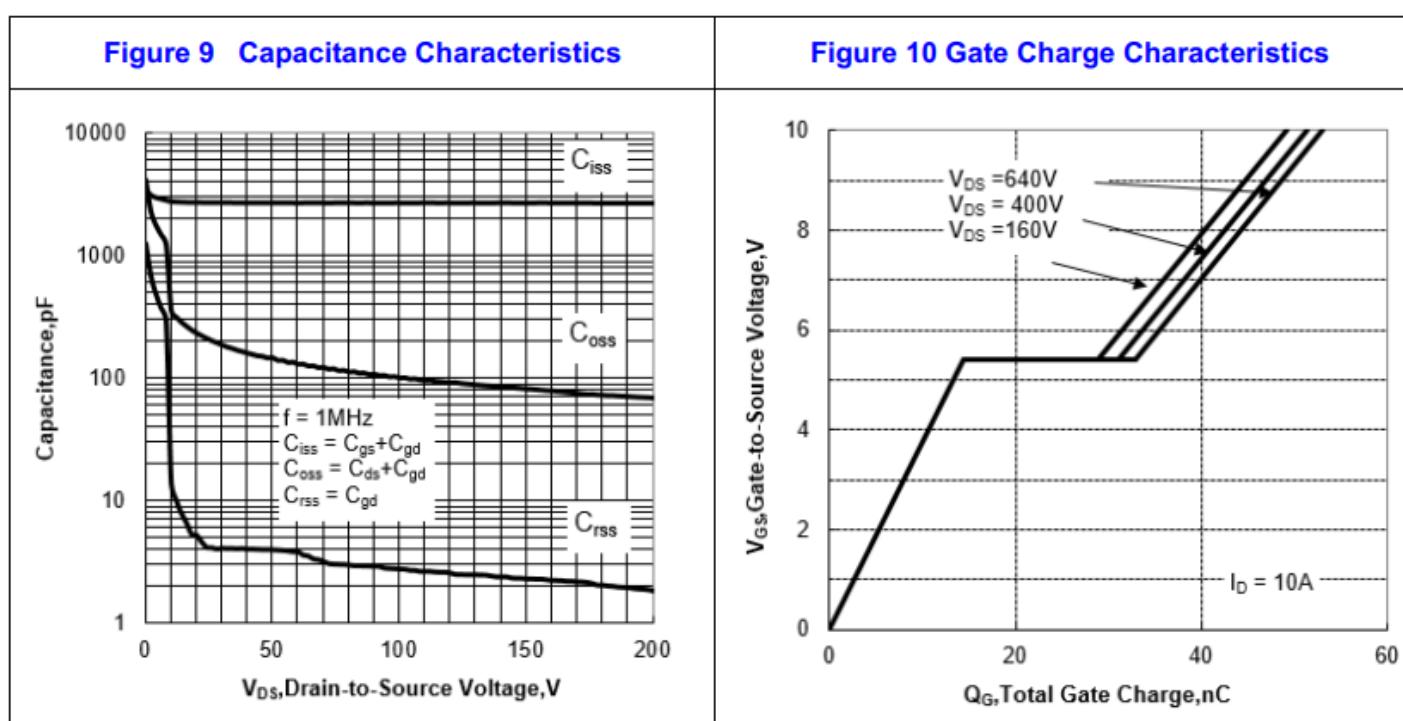
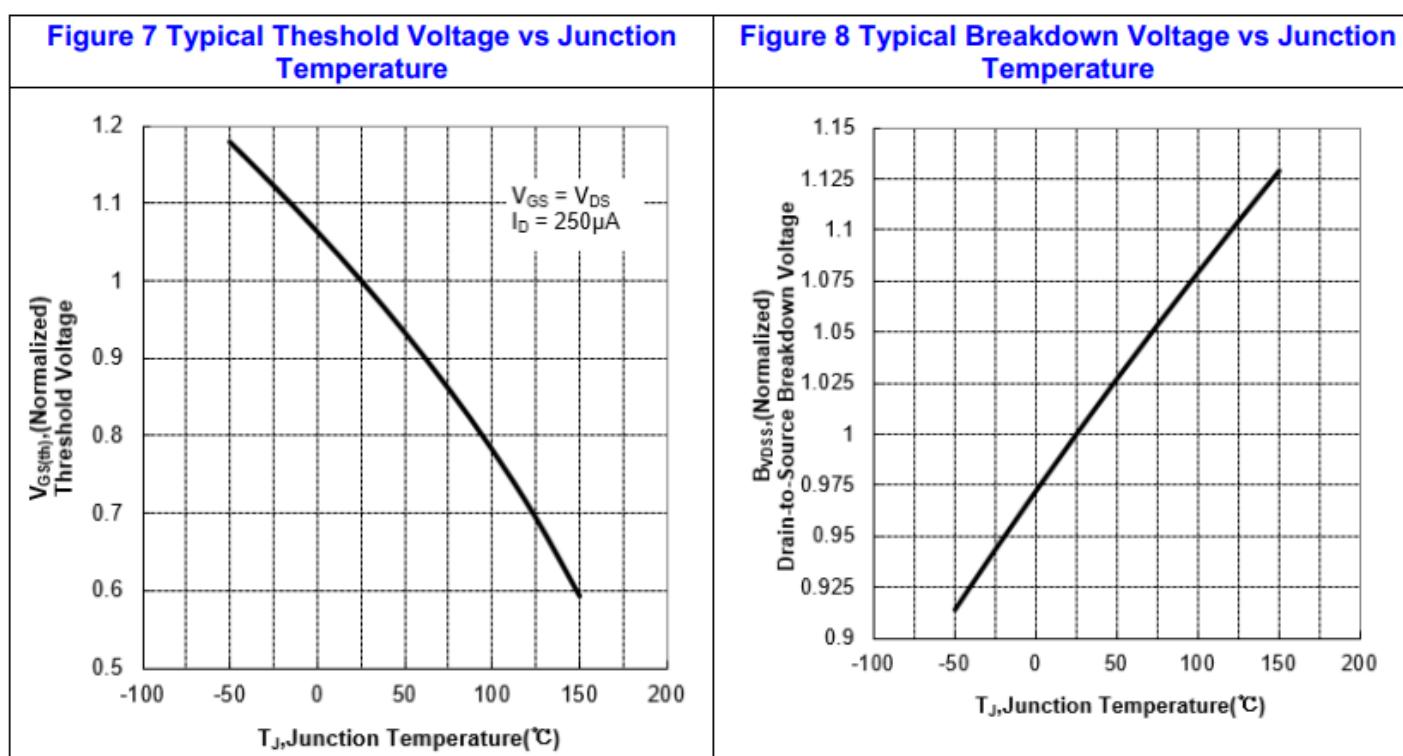
- 1: 脉冲宽度由最高结温限制
- 2: L=10mH, IAS=6.5A, VDS=50V, RG=25 Ω, 起始结温 TJ=25°C
- 3: ISD ≤10A,di/dt ≤100A/μs,VDD≤BV_{DSS},起始结温 TJ=25°C
- 4: 脉冲测试: 脉冲宽度 ≤300μs,占空比≤2%
- 5: 基本与工作温度无关

Notes:

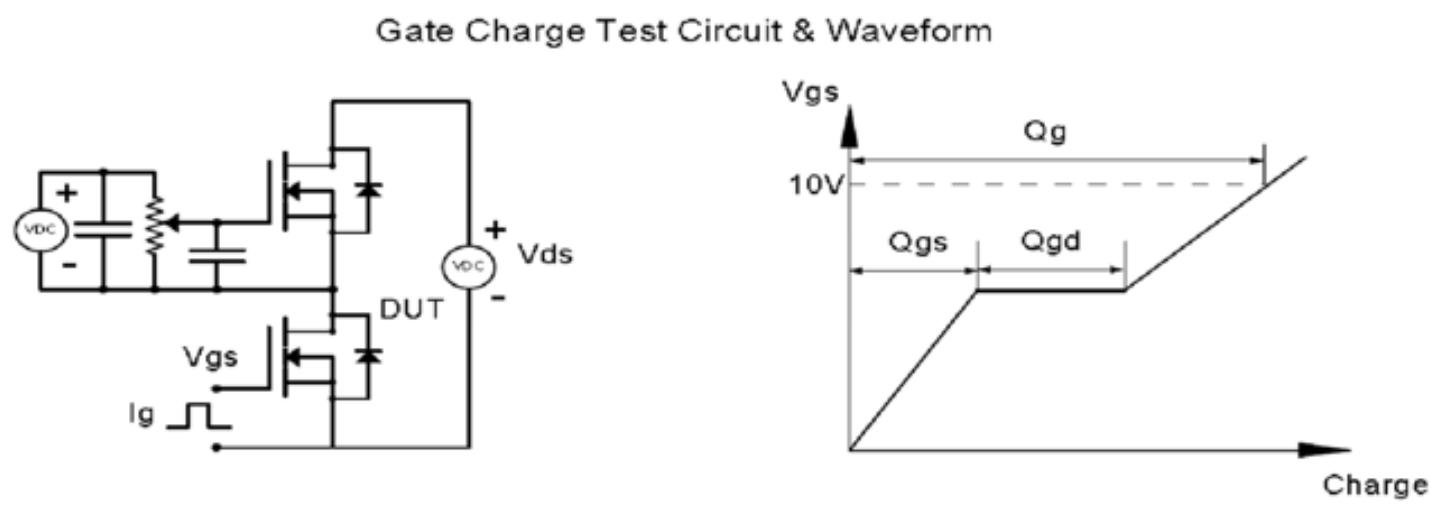
- 1: Pulse width limited by maximum junction temperature
- 2: L=10mH, IAS=6.5A, VDS=50V, RG=25 Ω ,Start TJ=25°C;
- 3: ISD ≤10A,di/dt ≤100A/μs,VDD≤BV_{DSS}, Starting TJ=25°C
- 4: Pulse Test: Pulse Width ≤300μs,Duty Cycle≤2%
- 5: Essentially independent of operating temperature

特性曲线 (ELECTRICAL CHARACTERISTICS (curves))

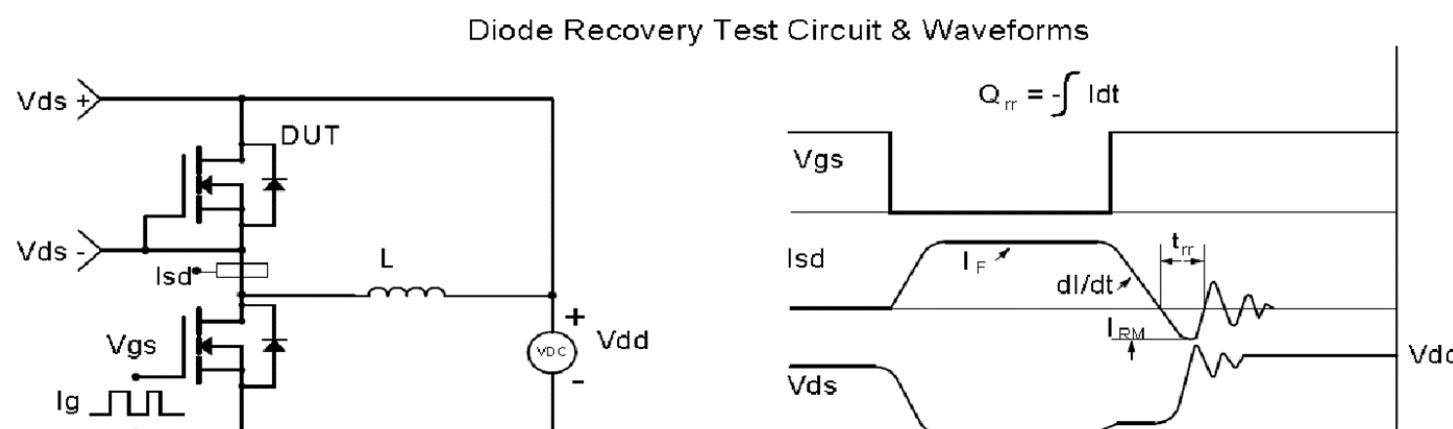
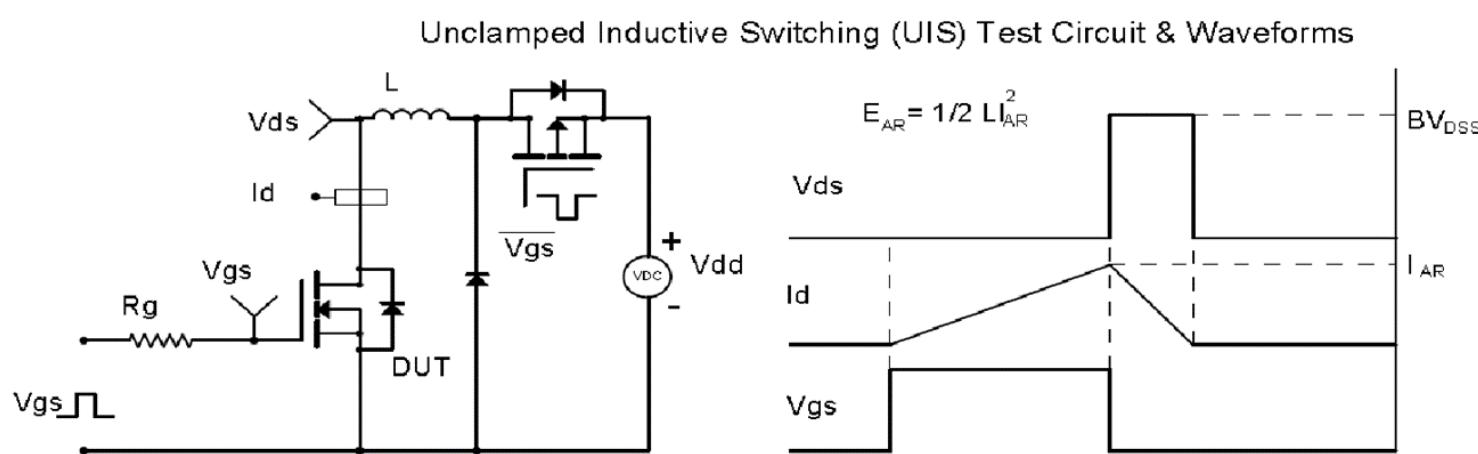
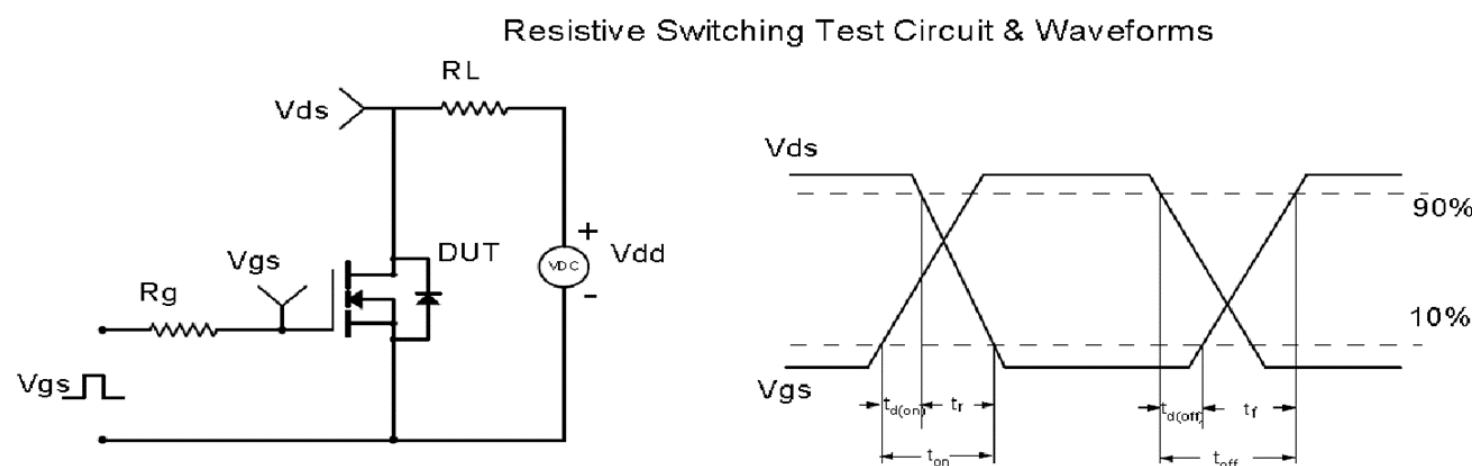




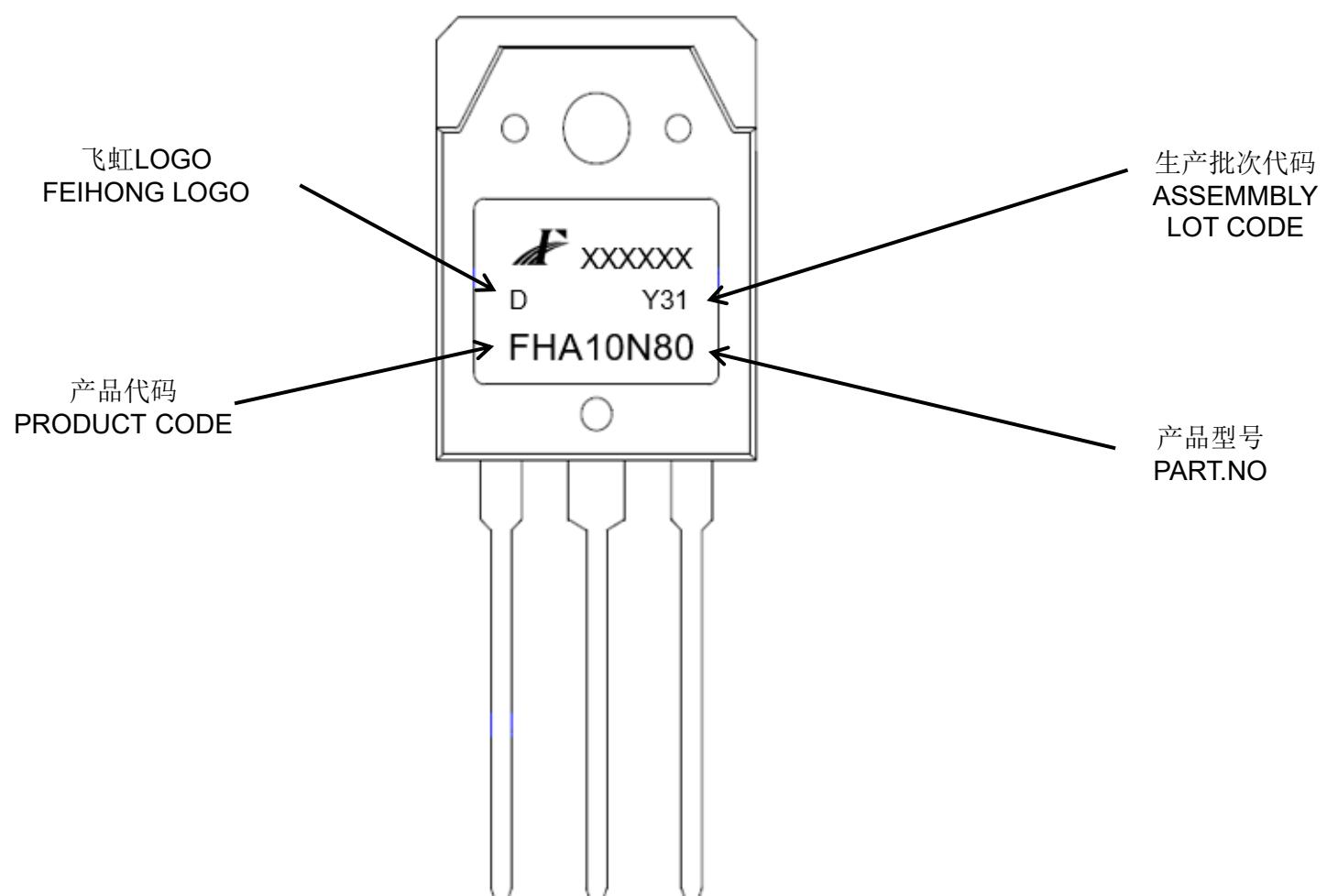
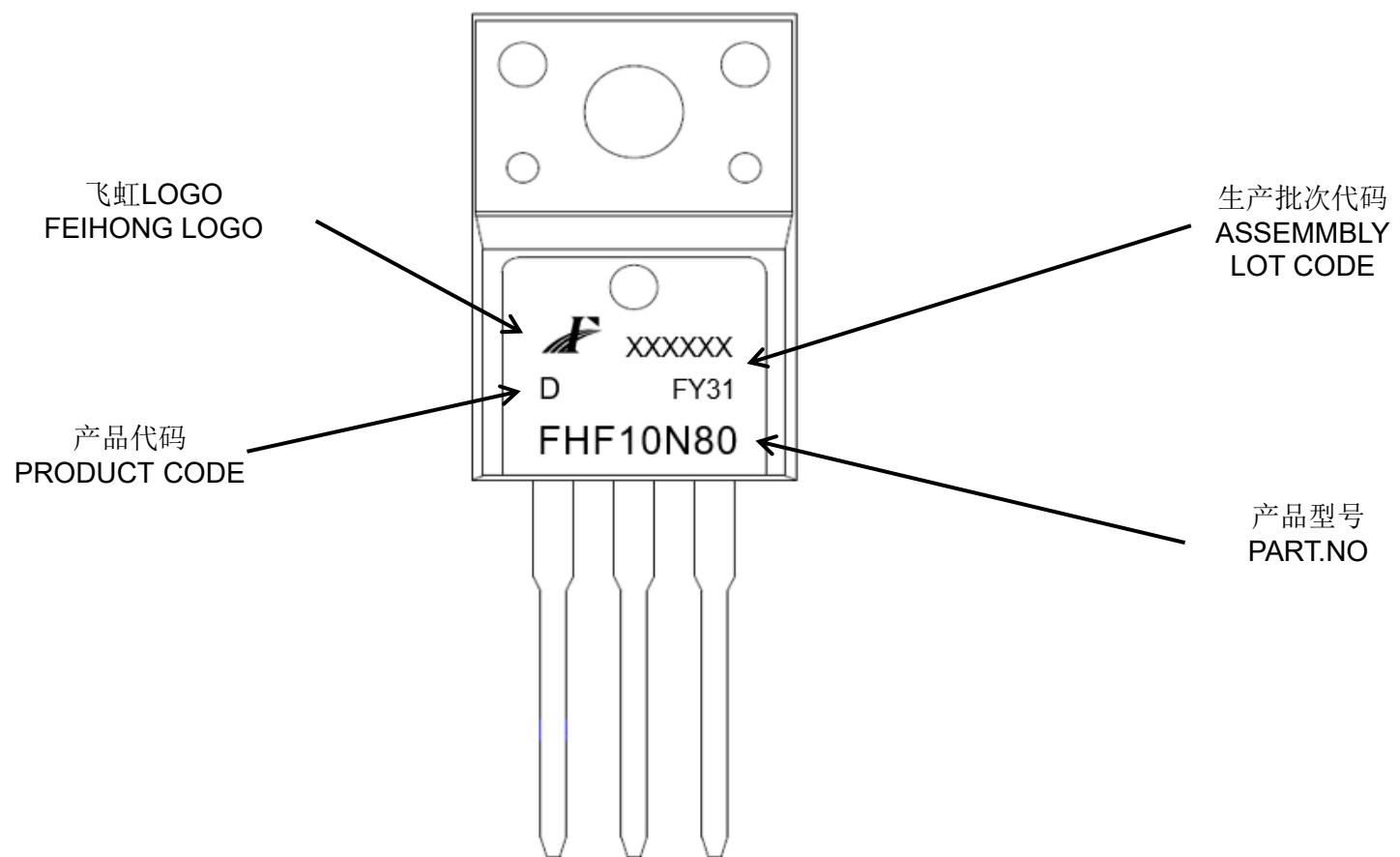
Test Circuit and Waveform



Resistive Switching Test Circuit & Waveforms



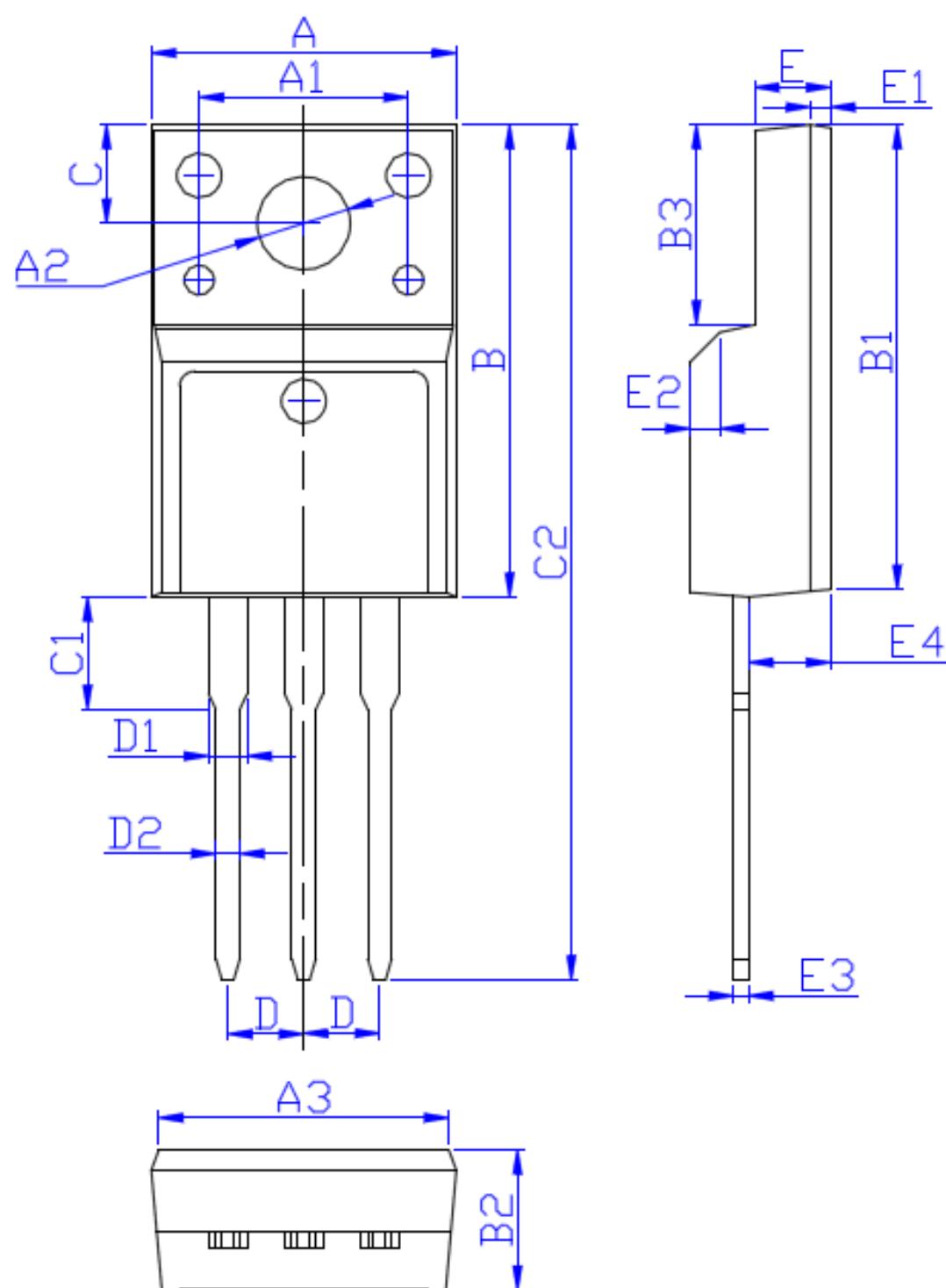
印记 Marking:



外形尺寸:

Package Dimension:

TO-220F



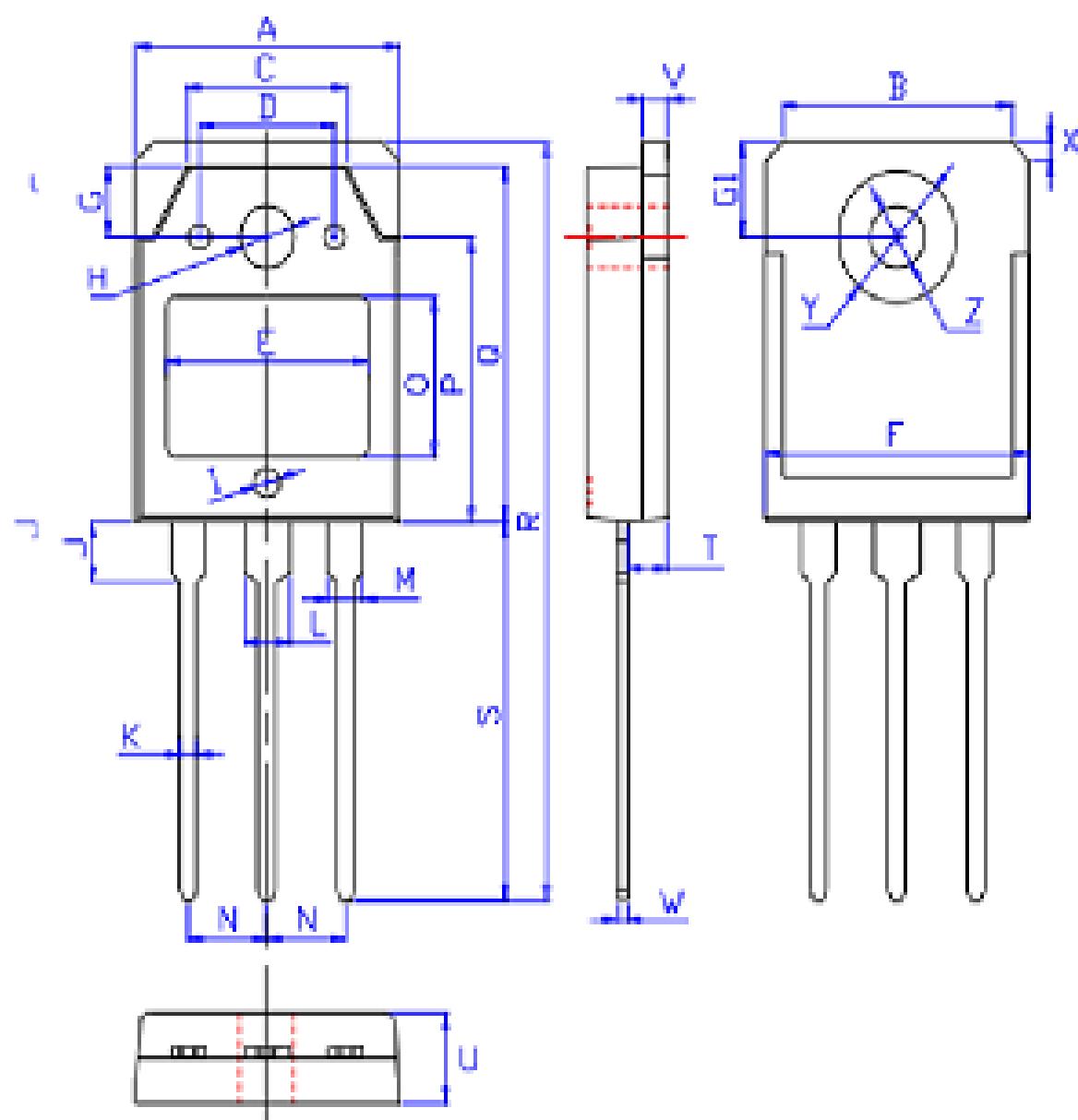
DIM	MILLIMETERS
A	10.16±0.30
A1	7.00±0.20
A2	3.12±0.20
A3	9.70±0.30
B	15.90±0.50
B1	15.60±0.50
B2	4.70±0.30
B3	6.70±0.30
C	3.30±0.25
C1	3.25±0.30
C2	28.70±0.50
D	Typical 2.54
D1	1.47 (MAX)
D2	0.80±0.20
E	2.55±0.25
E1	0.70±0.25
E2	1.0×45°
E3	0.50±0.20
E4	2.75±0.30

(Unit:mm)

外形尺寸:

Package Dimension:

TO-3PN



DIM	MILLIMETERS
A	15.60±0.30
B	13.60±0.30
C	9.50±0.30
D	8.00±0.30
E	11.85±0.30
F	15.65±0.30
G	3.80±0.30
G1	5.00±0.30
H	Φ3.50±0.30
I	Φ1.50±0.30
J	深0.15±0.15
K	3.20±0.30
L	1.00±0.15
M	3.10±0.15
N	2.10±0.15
O	5.45±0.30
P	8.40±0.30
Q	13.90±0.30
R	18.70±0.30
S	40.00±0.60
T	20.00±0.40
U	2.40±0.30
V	4.80±0.30
W	1.50±0.15
X	0.60±0.15
Y	1.80±0.40
Z	7.00±0.30
	3.20±0.30

(Units: mm)